



chemistry meets energy

Produktion supraleitender Drähte für die Energietechnik

Dr. Michael Bäcker

Deutsche Nanoschicht GmbH
Heisenbergstr. 16
53359 Rheinbach

HTS Drähte und Bänder

„Flexible Supraleiterbänder mit hoher Stromtragfähigkeit für energietechnische und industrielle Anwendungen werden heute kommerziell hergestellt.“

www.ivsupra.de

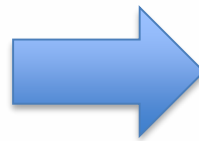
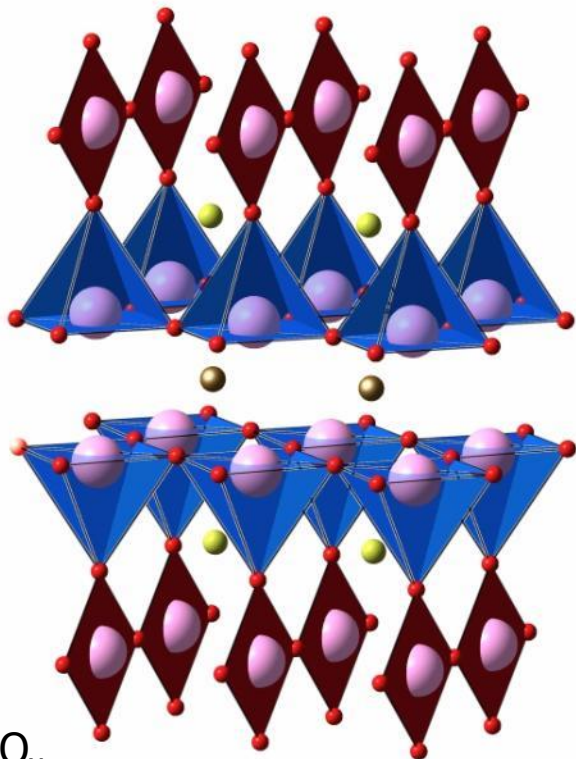
Inhalt

- Hochtemperatur Supraleiter
- HTS Bandleiter
 - Prozesstechnologie
- Hersteller und Kapazitäten
- Zusammenfassung

Hochtemperatur Supraleiter

- Herausforderndes Material (Stromtransport)

- Komplexe keramische Oxide
- Kristalline Schichtstruktur
- Starke Anisotropie

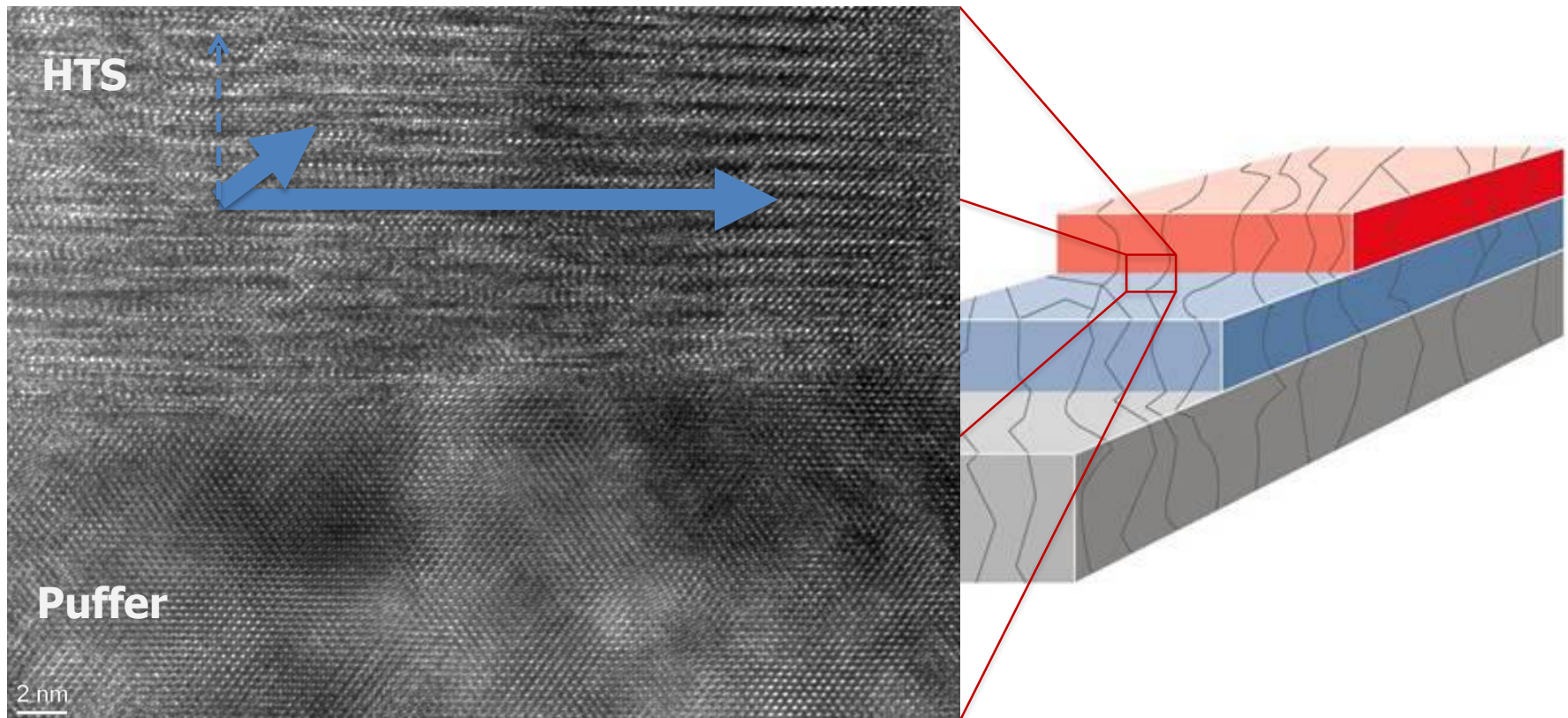


Supraleitender Strom:
parallel CuO-Ebenen >> senkrecht CuO-Ebenen

$\text{YBa}_2\text{Cu}_3\text{O}_x$

HTS Bandleiter

- HTS Architektur – dünne flexible Beschichtungen



HTS Bandleiter

- HTS Architecture – orientiertes epitaktisches Kristallwachstum



Statistisch orientiert



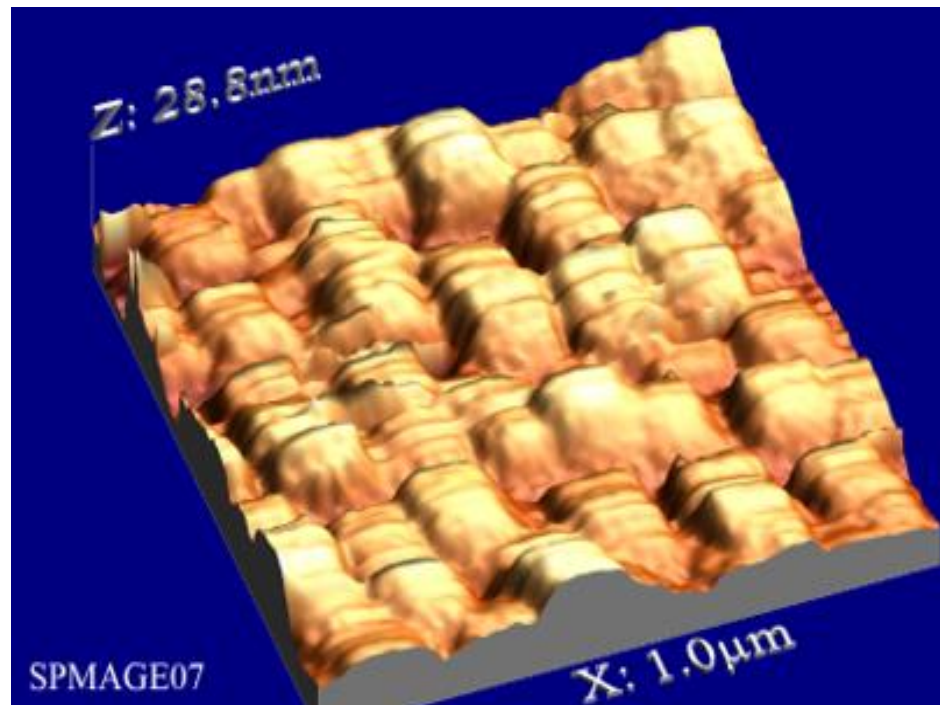
Hochorientierte kristalline Schicht



Schablone

HTS Bandleiter

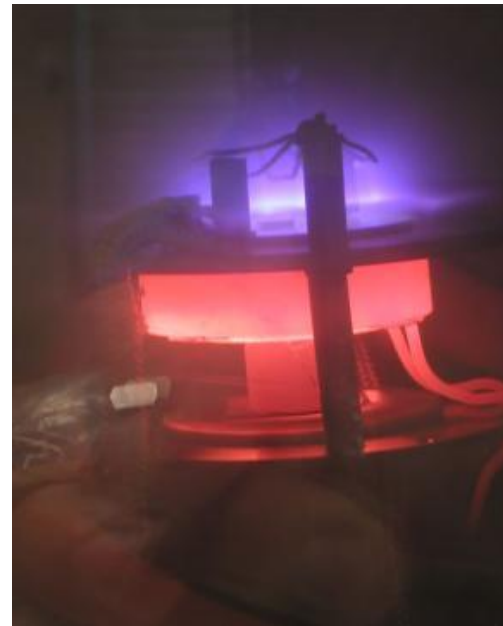
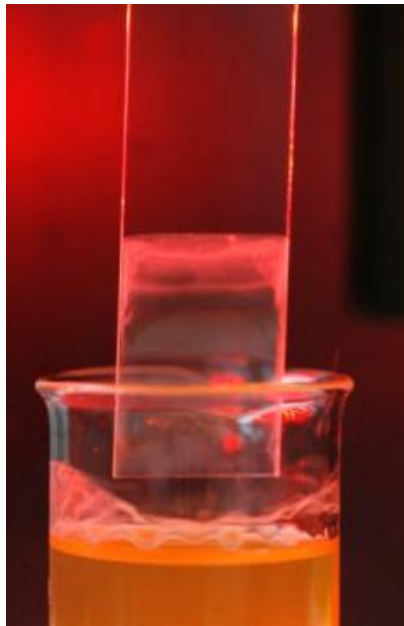
- HTS Architecture – orientiertes epitaktisches Kristallwachstum



AFM-Analyse einer Ceroxid Pufferschicht

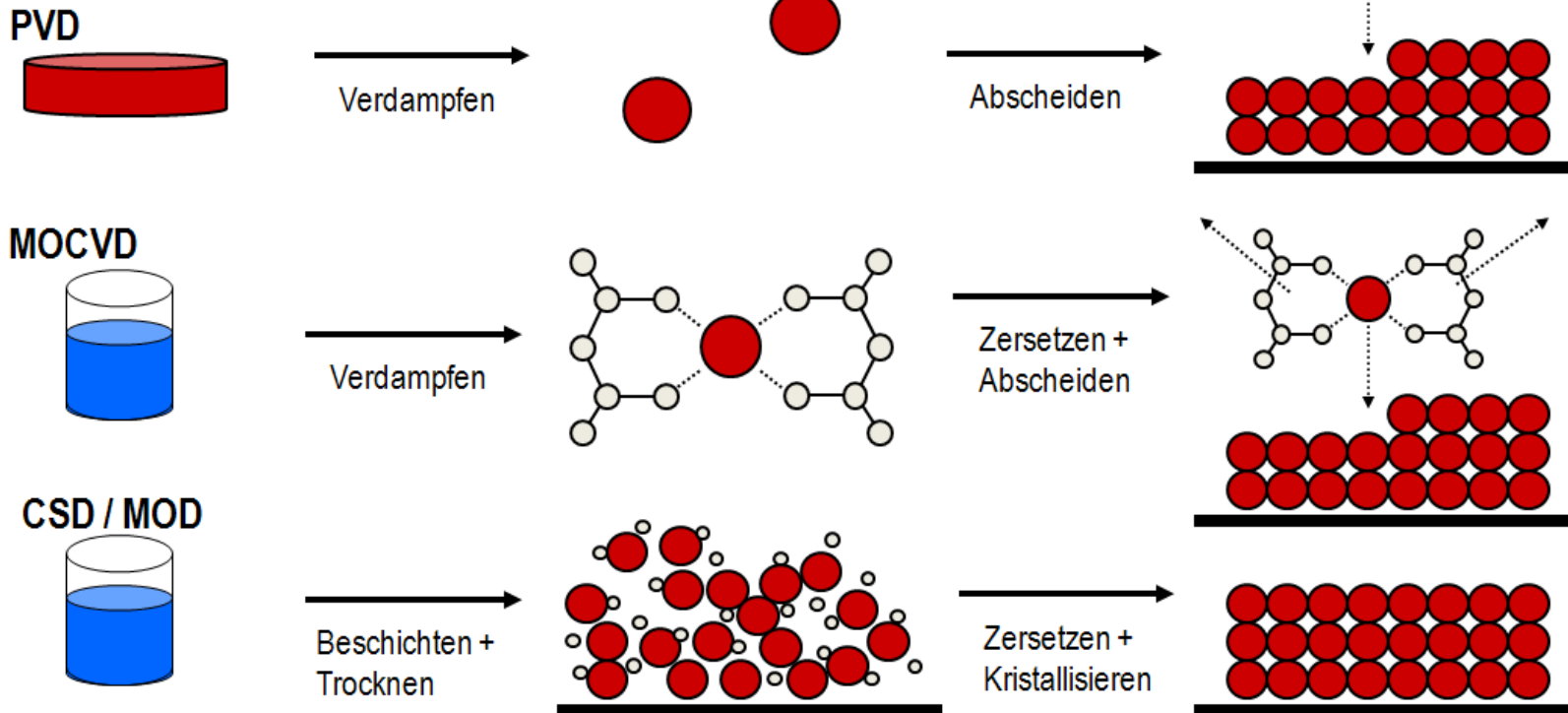
Prozesstechnologie

- Chemical solution deposition (CSD)
- Chemical vapour deposition (CVD)
- Physical vapour deposition (PVD)



Prozesstechnologie

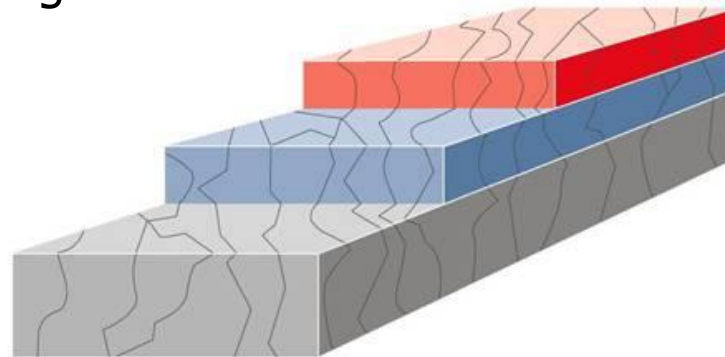
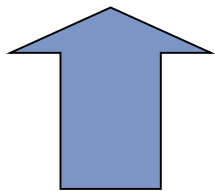
- CSD – CVD - PVD



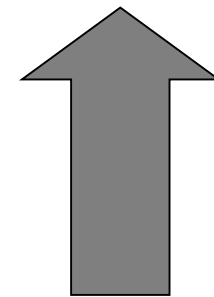
Prozesstechnologie

- orientiertes epitaktisches Kristallwachstum

Orientierung der
Pufferschicht
während Beschichtung



Verwendung von orientiertem
Metallsubstrat

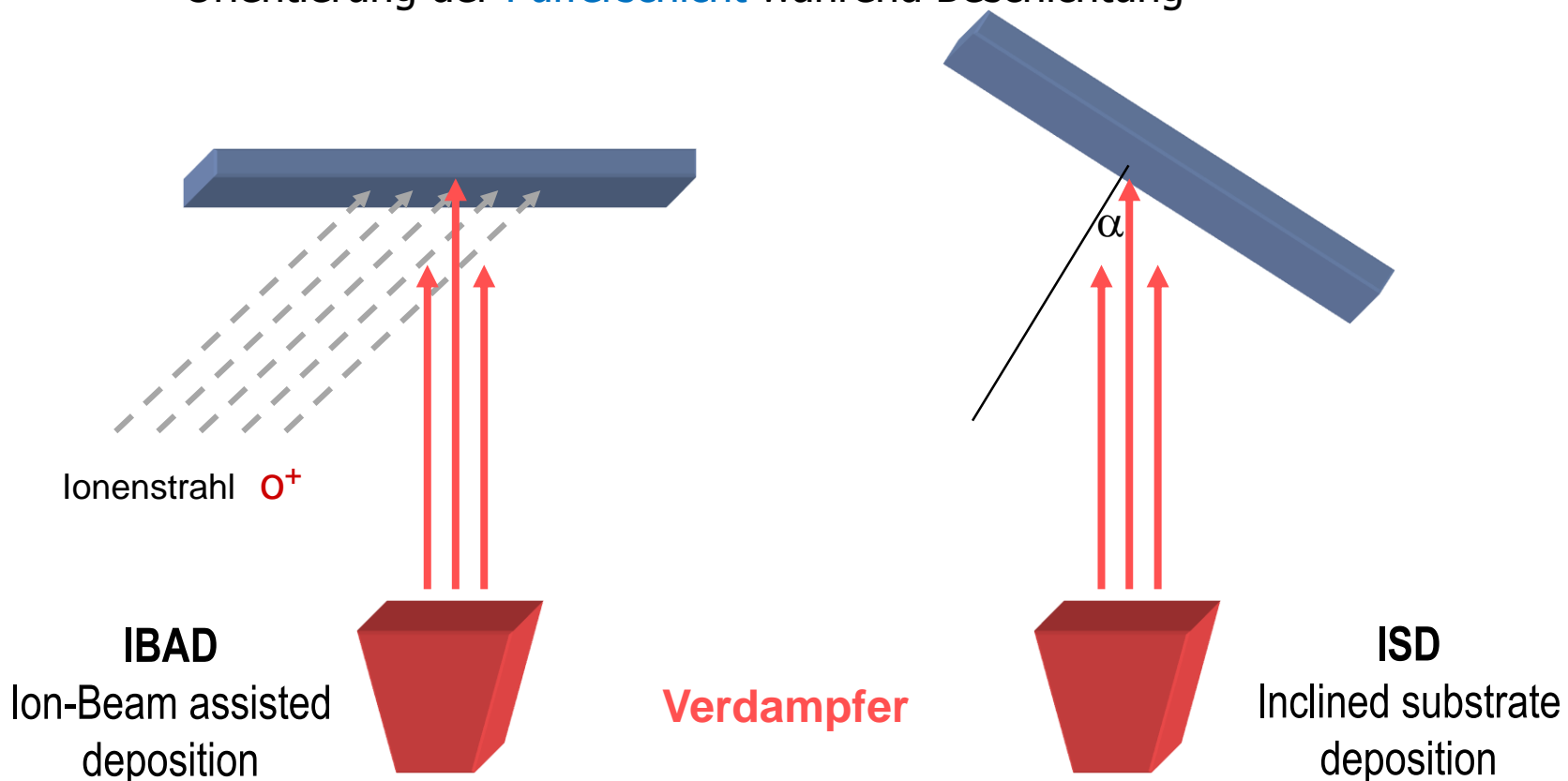


IBAD: Ion-Beam assisted deposition
ISD: Inclined substrate deposition

RABiTS™: Rolling assisted biaxially
textured substrate

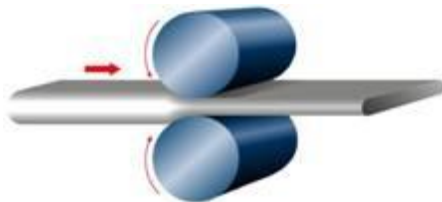
Prozesstechnologie

- orientiertes epitaktisches Kristallwachstum
 - Orientierung der **Pufferschicht** während Beschichtung

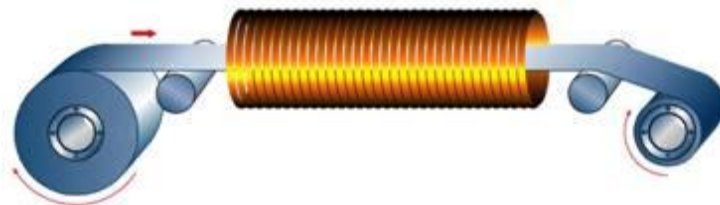


Prozesstechnologie

- orientiertes epitaktisches Kristallwachstum
 - Verwendung von orientiertem Metallsubstrat



Nickel-Wolfram-Legierungen
Kaltverformung >95%

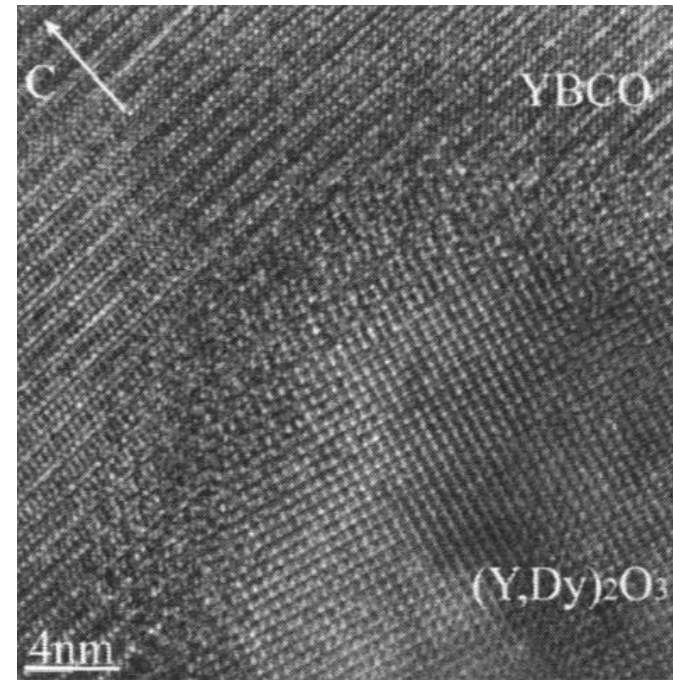
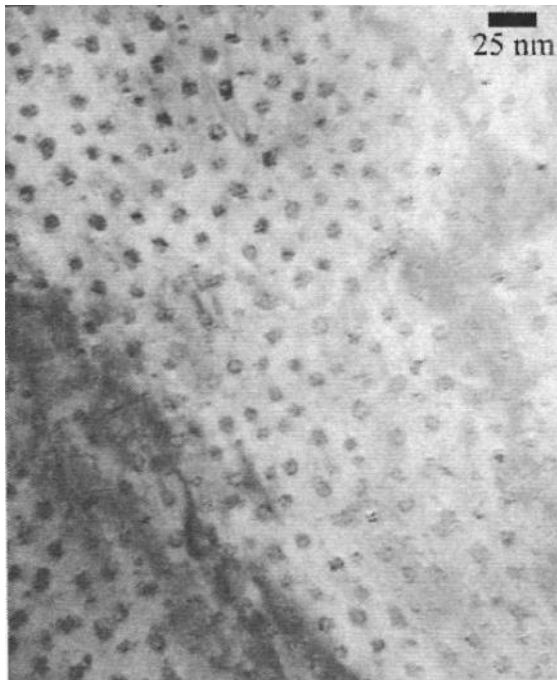


Rekristallisations-Glühung

RABiTSM: Rolling assisted biaxially textured substrate

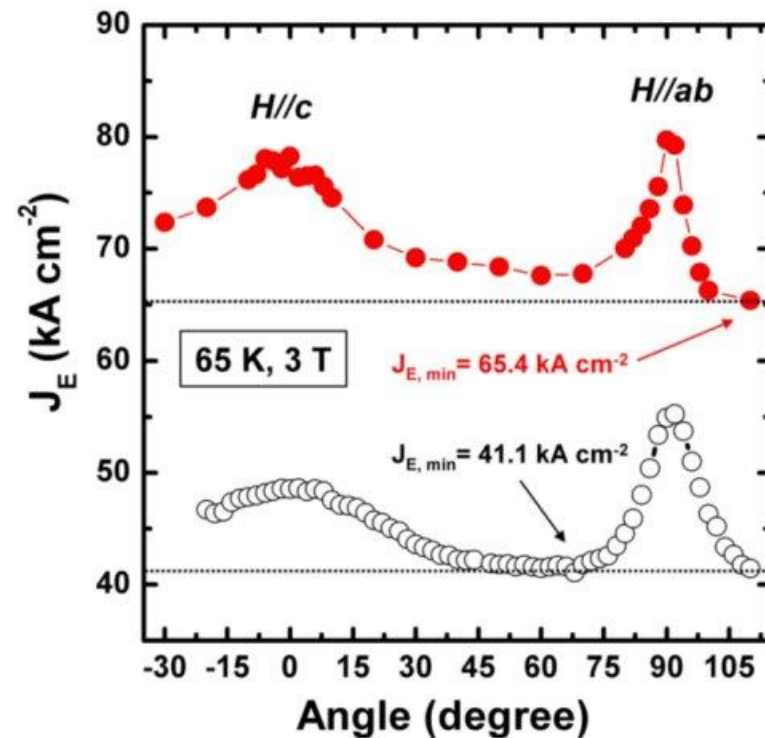
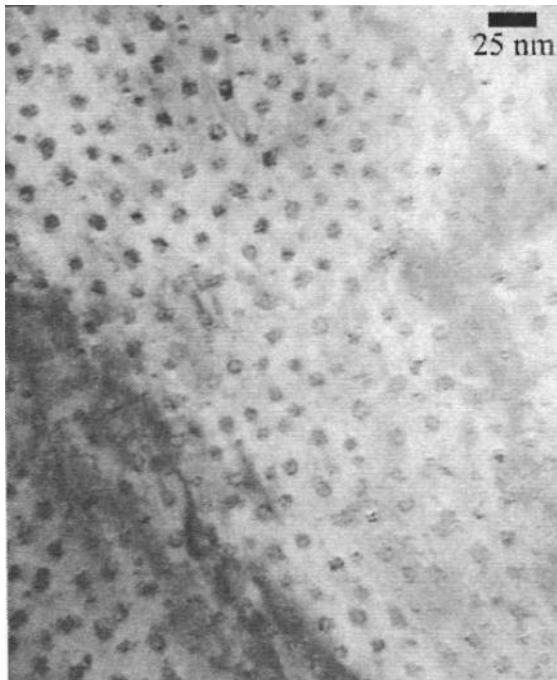
Prozesstechnologie

- Eigenschaften im Magnetfeld
 - Einbringen von Nanopartikeln in HTS Schichten
 - Möglich mit allen Herstellprozessen



Prozesstechnologie

- Eigenschaften im Magnetfeld
 - Einbringen von Nanopartikeln in HTS Schichten
 - Möglich mit allen Herstellprozessen



Hersteller und Kapazitäten



Hersteller und Kapazitäten

Beiträge von:

- **THEVA**
- **Bruker HTS**
- **SUNAM**
- **STI**
- **SWCC**
- **AMSC**
- **Deutsche Nanoschicht**

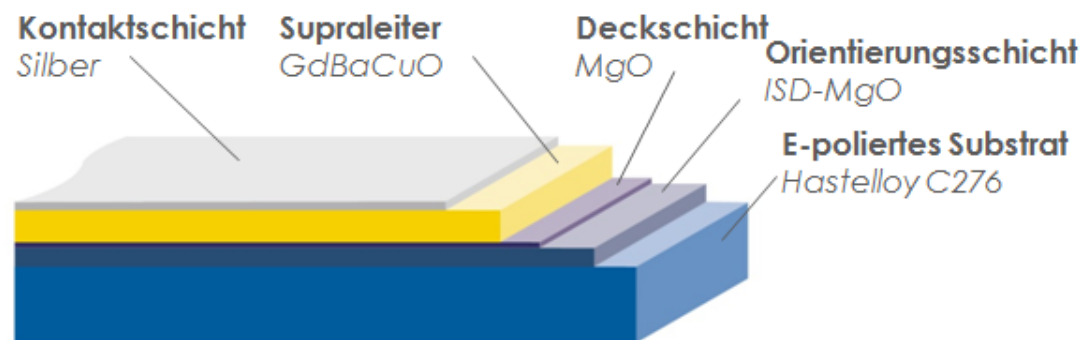
**Für Details wenden
Sie sich bitte direkt
an die Aussteller**

Alle folgenden Folien wurden von den oben genannten Firmen zur Verfügung gestellt. Für den Inhalt sind die Firmen verantwortlich.

THEVA PRO-LINE

Der HTS – Bandleiter von THEVA

- Zuverlässig striktes Qualitätsmanagement
- Leistungsstark extrem hohe Stromtragfähigkeit
- Wettbewerbsfähig Kosteneffiziente, industrielle Fertigungstechnik

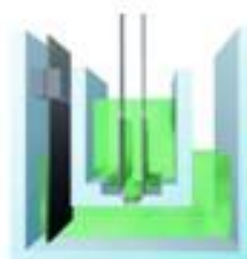


VERFAHRENSTECHNIK

Durchgängige PVD – Abscheidung (e-Strahl-Verdampfen)

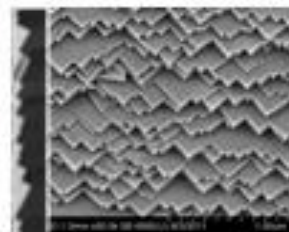
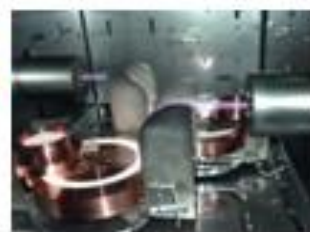
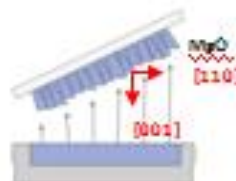
Substrat

- Hastelloy C276, unmagnetisch
- Hohe Festigkeit > 500 MPa
- Reinigung & Elektropolitur



MgO-Pufferschicht

- Schrägbedampfen (ISD)
- biaxiale Orientierung, FWHM < 10°
- 25° Verkippung, gestufte Oberfläche



Bandrichtung →

GdBa₂Cu₃O₇-Schicht

- Kontinuierliche E-Strahlverdampfung
- Hohe Abscheiderate
- Stöchiometrie fest vorgegeben durch Pulver



HTS - BANDLEITERFERTIGUNG

Modernste Produktionstechnik

Merkmale der Pilotfertigung

- Modulare, vollautomatische Anlagen
- Kontinuierliche Ein- und Ausschleusung
- Inline Qualitätskontrolle
- Geschwindigkeit aktuell: >30 m/h @ 12 mm Breite
- Leiterlänge: 60m (aktuell) – 600m (bis Ende 2016)
- Ausbeute: > 70% (Kriterium: $I_c > 360A$, $L > 25m$)

Zielsetzung

- Hohe Kosteneffizienz in der Produktion
- Robuste Prozesse mit hoher Ausbeute
- Implementierung industrieller Standards
- Durchgängige Qualitätssicherung



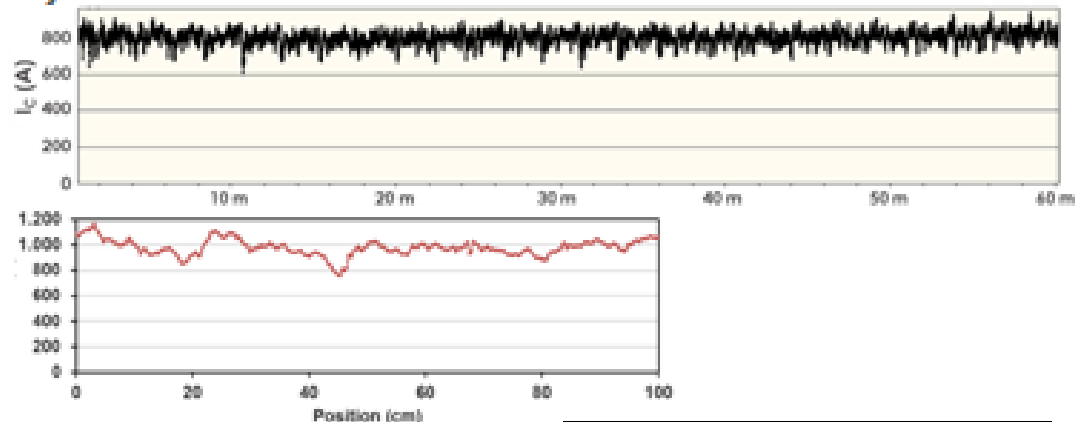
Alle folgenden Ergebnisse aus der Produktion

ERGEBNISSE

Leistungsfähigkeit – 60 m Prozesslänge

Stromtragfähigkeit (@ 12 mm)

- $I_{c,min}$ bis zu 600 A
- $I_{c,avg}$ bis zu 800 A
- $I_{c,max}$ bis zu 1200 A



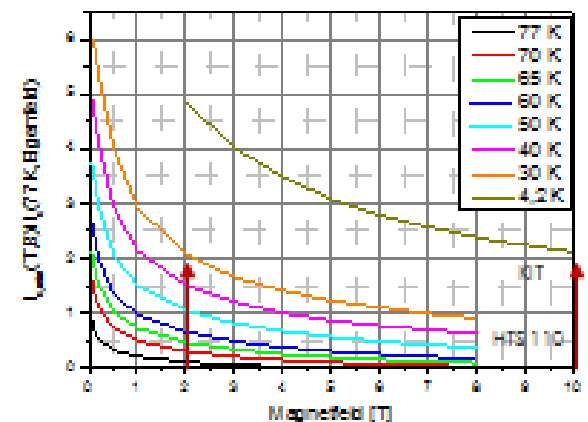
Gute Magnetfeldverträglichkeit

Lift-Faktoren:

$$I_c(30K, 2T) / I_c(77K, s.f.) = 2$$

$$I_c(4.2K, 10T) / I_c(77K, s.f.) = 2$$

vergleichbar zu AMSC „enhanced pinning“



TECHNISCHE LEITER UND ANWENDUNGEN

Konfektionierung und Magnetspulen

Elektrische Stabilisierung

- Laminierung:

100 μm Cu-Folie einseitig

TPL 12100 CU100



50 μm Cu-Folie doppelseitig

TPL 13100 CU2x50



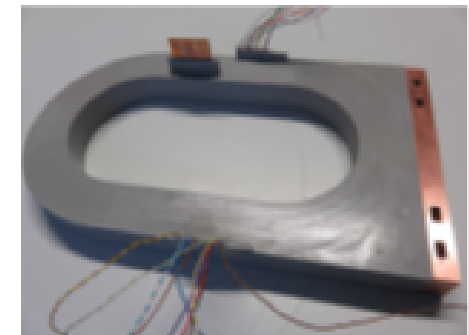
- Galvanik: 10-20 μm Kupfermantel

TPL 12100 CU2x20



Spulenbau (EcoSwing Windkraft-Generator)

- Industrielle Wickeltechnik
- Niederohmige Kontakte ($< 10 \text{ n}\Omega$)
- Spulenverguss für robuste Spulen und zur Aufnahme großer Kräfte



EcoSwing 2T-Testspule
mit Sonderabgriffen

Capabilities of BHTS pilot-lines

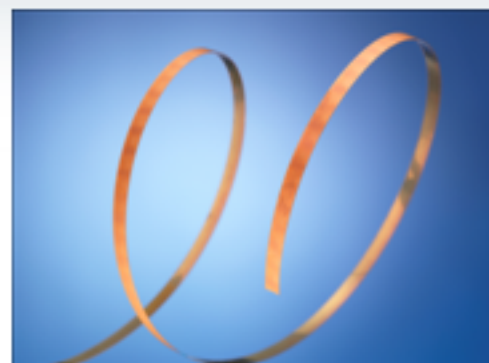
- BHTS main mission: manufacturing of 2G HTS coated conductors
- Two production lines in Alzenau:
 - Pilot-line for 4mm wide HTS tapes with the capability to process a max. single piece tape length of **600m**

IN OPERATION

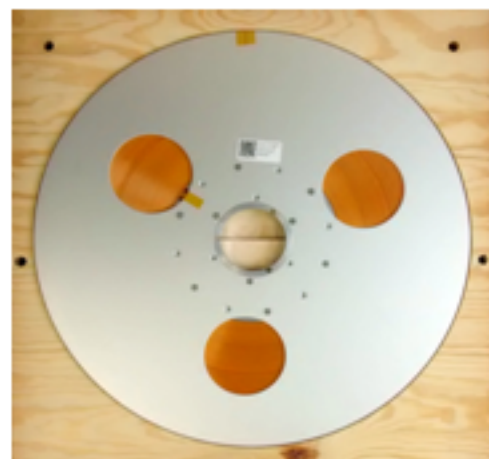
- Pilot-line for 12mm wide HTS tapes with the capability to process a max. single piece tape length of **100m**

RAMP-UP IN PROGRESS

- Comprehensive testing devices for process and quality control of coated conductors



4mm wide HTS tape without insulation

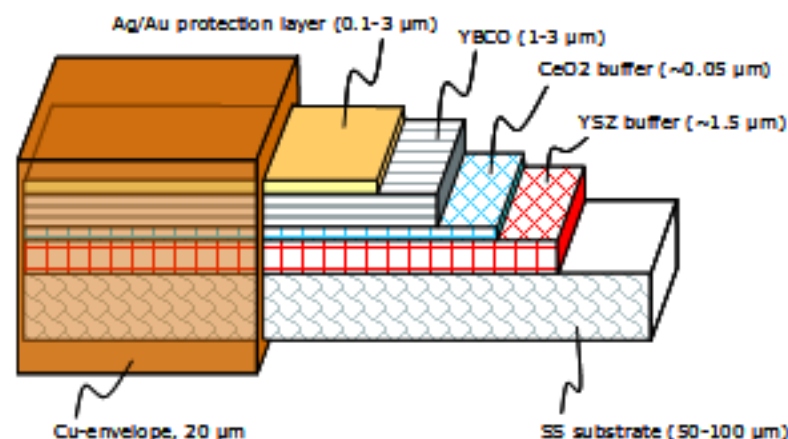


4mm wide HTS tape with insulation on a 20" reel

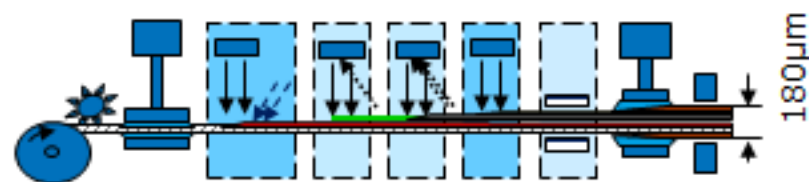
BHTS's process chain

- The standard processing route for the BHTS coated conductors consists of ...
 - ... stainless steel substrate polishing and cleaning
 - ... YSZ buffer layer coating by vacuum deposition (ABAD)
 - ... Ceria and YBCO layer coating by vacuum deposition (PLD)
 - ... Ag shunt layer coating by vacuum deposition (evaporation) and Ag layer annealing in O₂ atmosphere
 - ... Cu encapsulation by plating
 - ... final inspection and quality check of the HTS tapes

Typical HTS layer stack

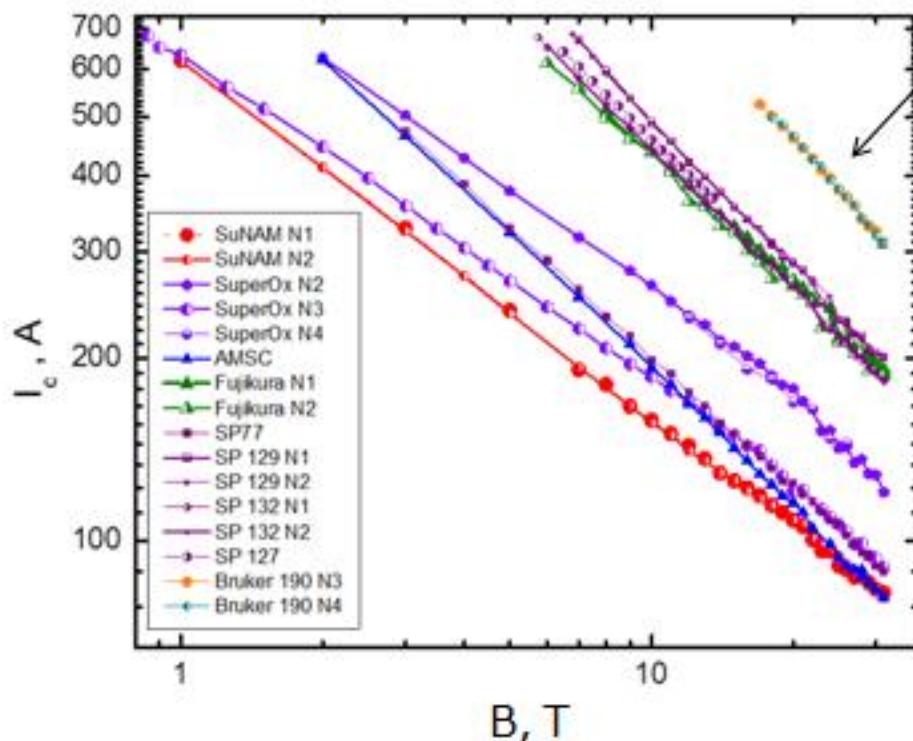
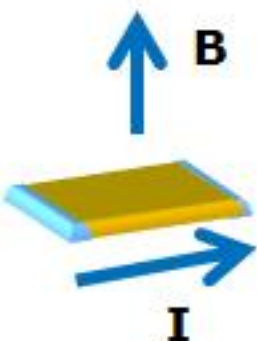


Idealized sketch of the BHTS process chain



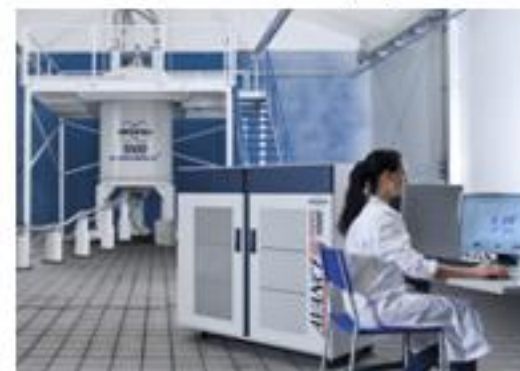
BHTS's core competence

- I_c in-field performance @ (4K, B up to 31T) of coated conductor samples from different manufacturers measured at FSU in November 2014
- An I_c value of 309A at 4K, 31T was obtained for the 4mm wide BHTS tape samples



BHTS tapes ...

... which fulfills the I_c requirements for the next generation of BRUKER BIOSPIN persistent superconducting magnet for NMR spectroscopy



Pilot-line equipment

- Tape processing equipment with different substrate handling concepts (batch and reel-to-reel R2R processes)



PLD600
Batch vacuum coating



EPOL3
R2R electropolishing



ABAD3
R2R vacuum coater



PLD600
substrate drum

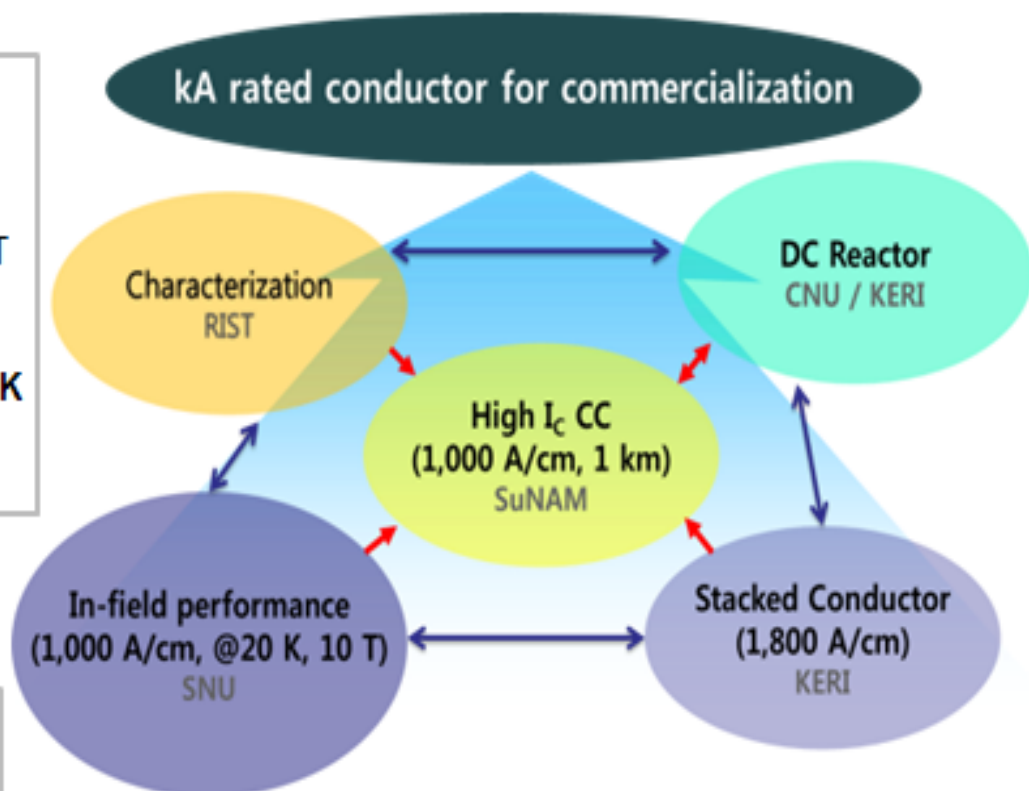
New Gov't Sponsored Coated Conductor Project

Target

- Critical current; $I_c > 1,000 \text{ A/cm}$ @77 K, s.f.
(length > 1 km, uniformity > 96%)
- In-field performance; $I_c > 1,000 \text{ A/cm}$ @20 K, 10 T
- Stacked conductor; $I_c > 1,800 \text{ A/cm}$ @77 K, s.f.
- I_c measurement tech.; 0-10 T, > 1,800 A/cm, 20~77 K
- DC reactor demo; 400 mH, 1,500 A

Budget

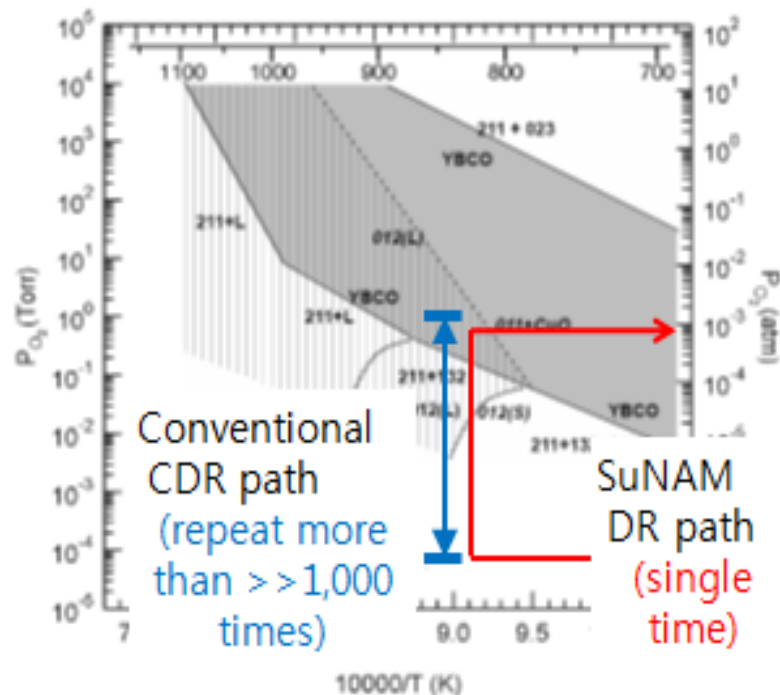
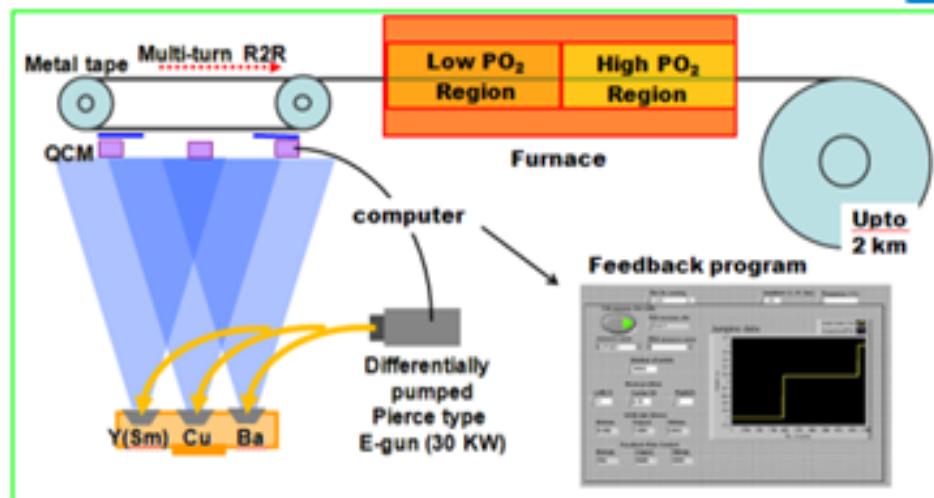
~US\$13M; \$9M from Gov't, \$4M from SuNAM
(June 2013 ~ May 2017, 4 years)



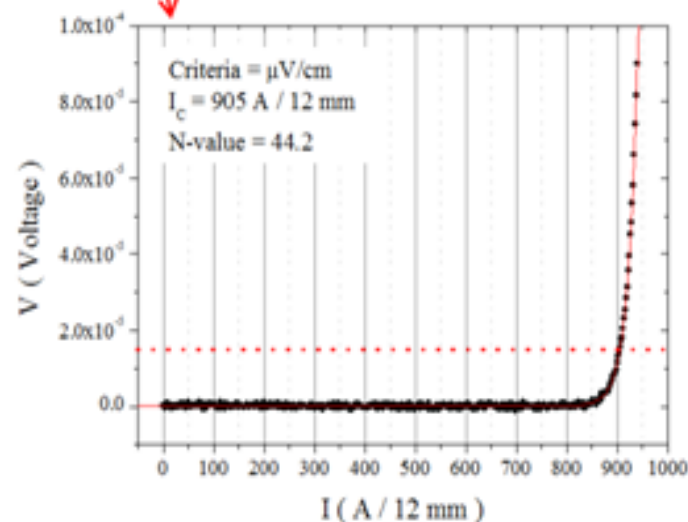
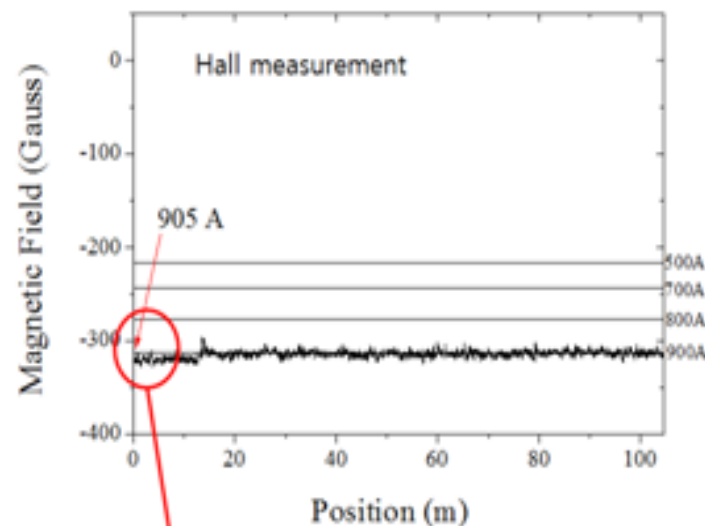
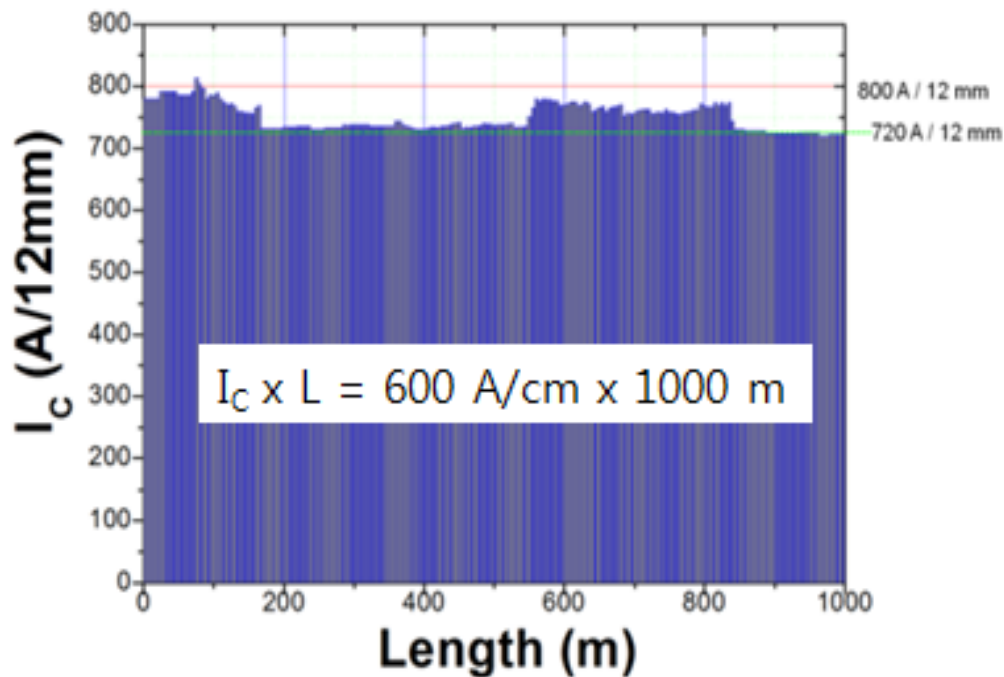
➔ Sponsored by Ministry of Trade, Industry & Energy(MOTIE),
through Inst. of Energy Tech. Evaluation and Planning(KETEP)

SuNAM RCE-DR process

- RCE-DR : Reactive Co-Evaporation by Deposition & Reaction (SuNAM, R2R) : Patent pending(PCT)
- High rate co-evaporation at low temperature & pressure to the target thickness ($> 1 \mu\text{m}$) at once in deposition zone (6 ~ 10nm/s)
- **Fast ($\ll 30 \text{ sec.}$) conversion** from **amorphous glassy phase** to **superconducting phase** at high temperature and oxygen pressure in reaction zone
- Simple, higher deposition rate & area, low system cost
- **Easy to scale up** : single path



RCE-DR Results on Stainless Steel Substrate





(4)-Step Superconducting Wire Manufacturing



SDP

1km x
100 mm
Ceramic
Coating
SST / C-276

1



IBAD

1km x 12mm
MgO
Template

2



RCE

1km x 12mm
2G HTS + Ag
Cap

3



METALS

(Optional)
Ag / Cu /
Other
Varying Thick
(μm)

4



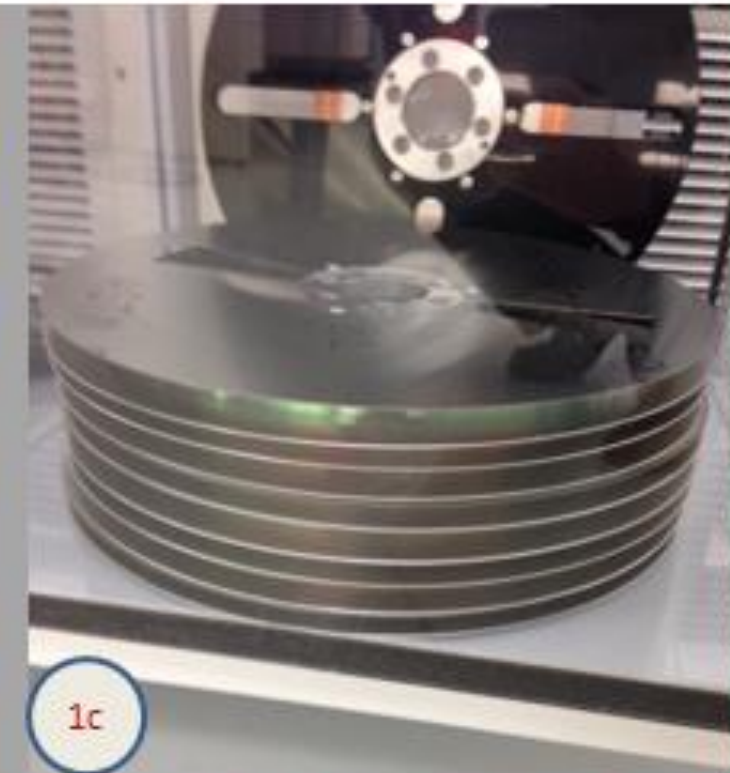
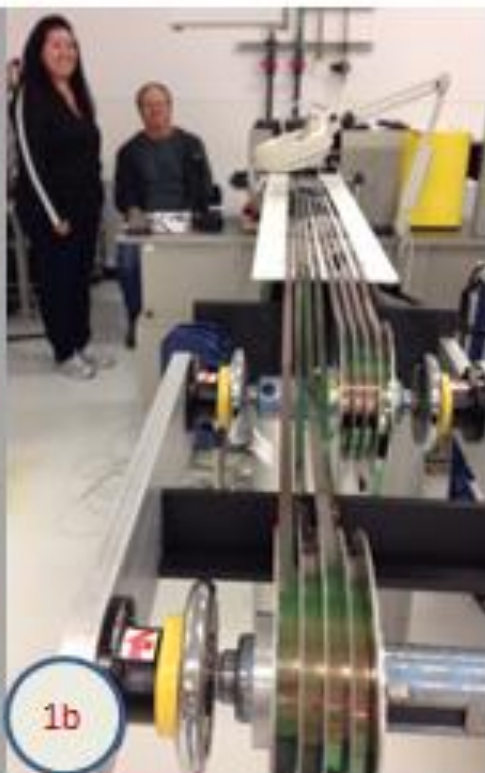
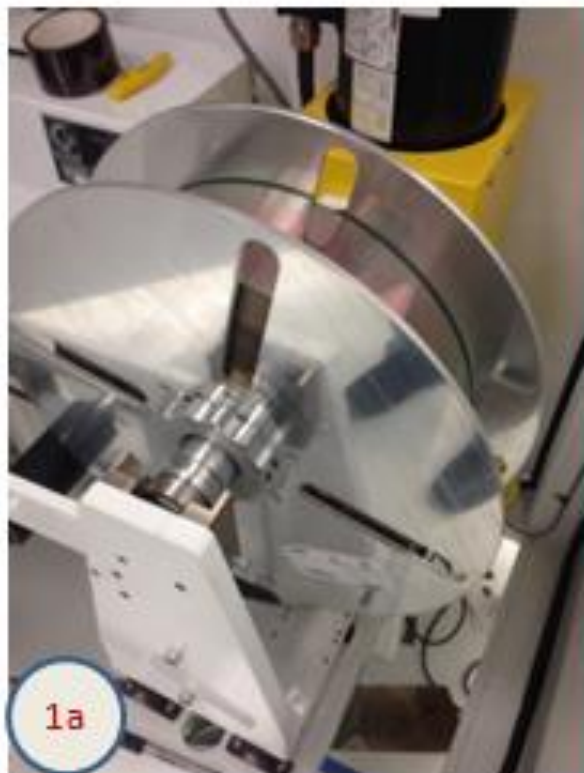
STEP 1 - 1km SDP Planarized Tape

1km x 100mm Wide
Ceramic/SDP
Coated Substrate

EXAMPLE:

Slitting to (8X) 12mm Wide
(Typical Product Dimension)

(8X) 1km length Reels
12mm width Planarized
Coated Substrate



Atmospheric
Reel-to-Reel Process

OPTIONAL Slitting Width – Product Configuration Flexibility



STEP 2 - 1km IBAD Template & Qualification





STEP 3 - 2G HTS Tape Completed // Measure

UNLOADING:

12mm x 400
meter length
(RE)BCO HTS
with Silver
cap layer



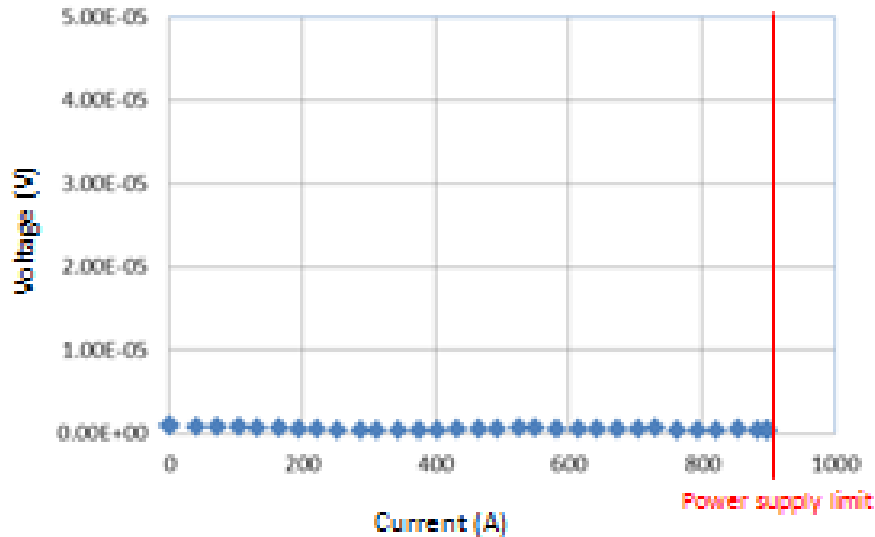
METROLOGY: TapeStar XL
Atmospheric, Reel-to-Reel

Tape Product Width:	3mm	4mm	10mm	12mm	100mm (tbd)
Batch Size: (meters)	3000	2150	1000	850	100
<u>Capacity:</u> Kilometers/Year/Machine	950	750	300	250	25

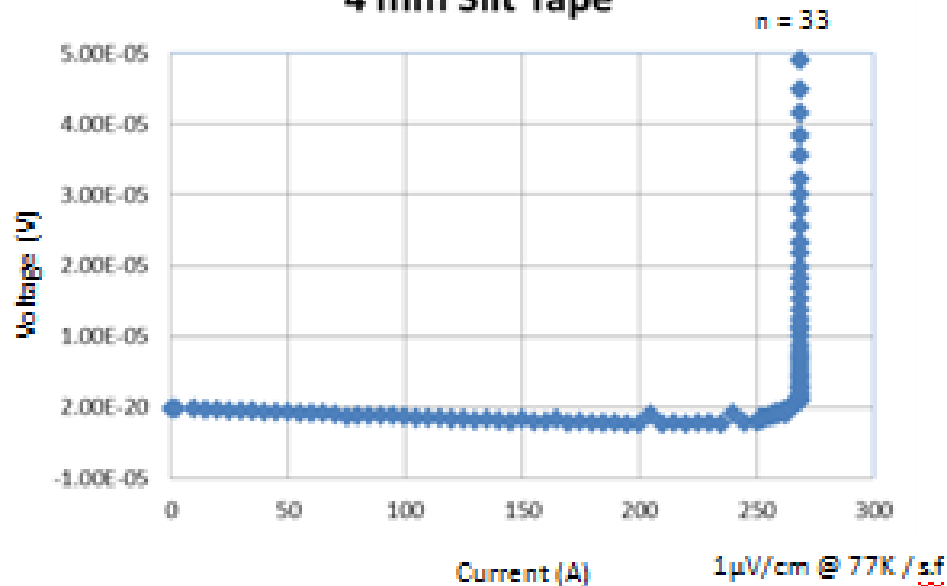


Conductus[®] Ic Measurement

12 mm Wide Tape



4 mm Slit Tape



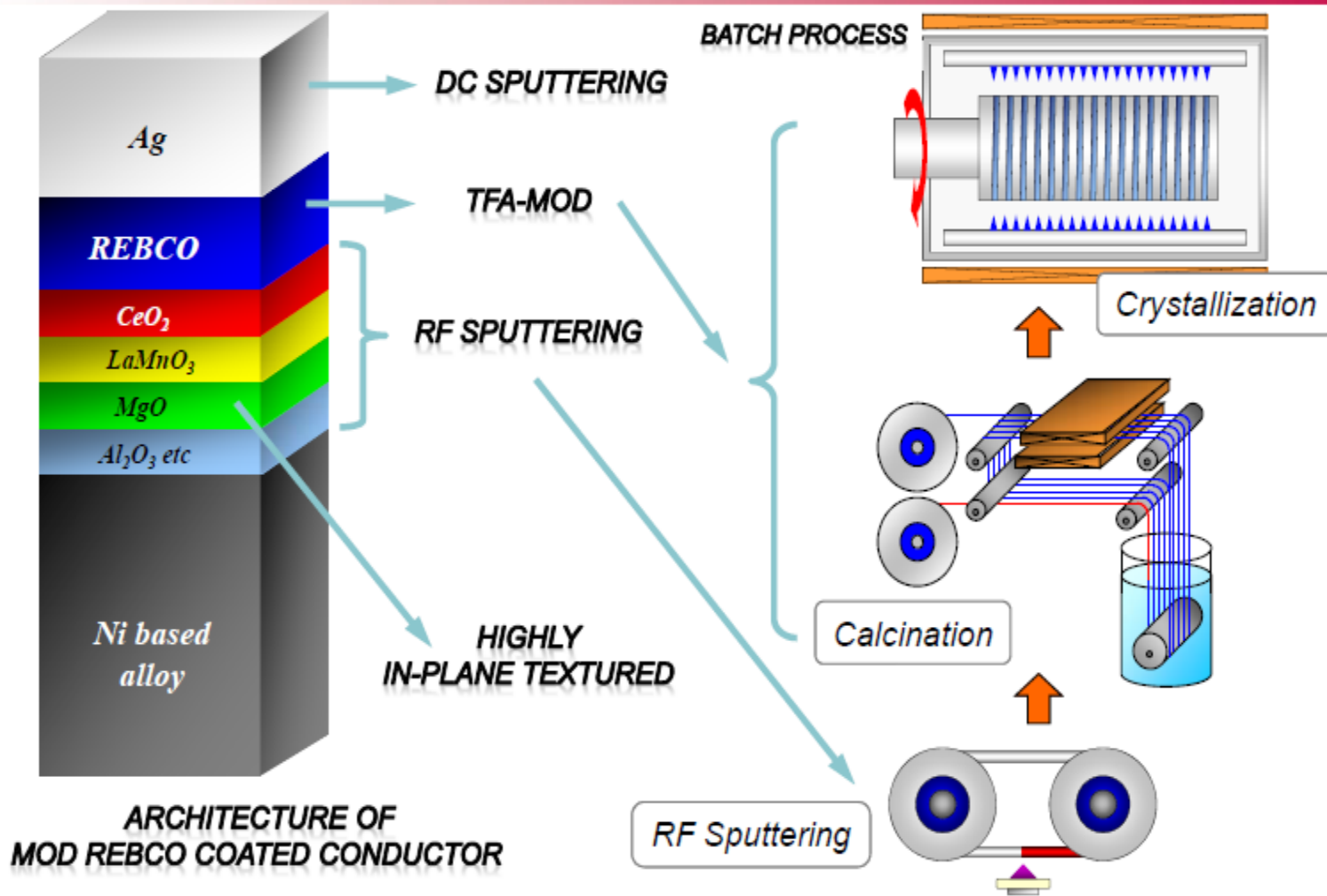
Direct Ic measurement maxed out at 900A for 12 mm tape (power supply limit)

- Slit same tape to 4mm and measured 269A
- This corresponds to 807A – lower than 12 mm due to slitting loss (~ 10%)
- 4mm tape cut on both edges

MOD REBCO Coated Conductor



Creating for the Future



Specifications of HTS cable system








Item	Specifications
Rated voltage	35kV
Nominal voltage (U_0)	21kV
Continues rated current	600A
Critical current (I_c)	1200A
Withstand AC voltage ($2.5U_0$)	53kV
Withstand lightning impulse voltage	200kVp
Short circuit current	25kA 2second



Amperium® Wire Products

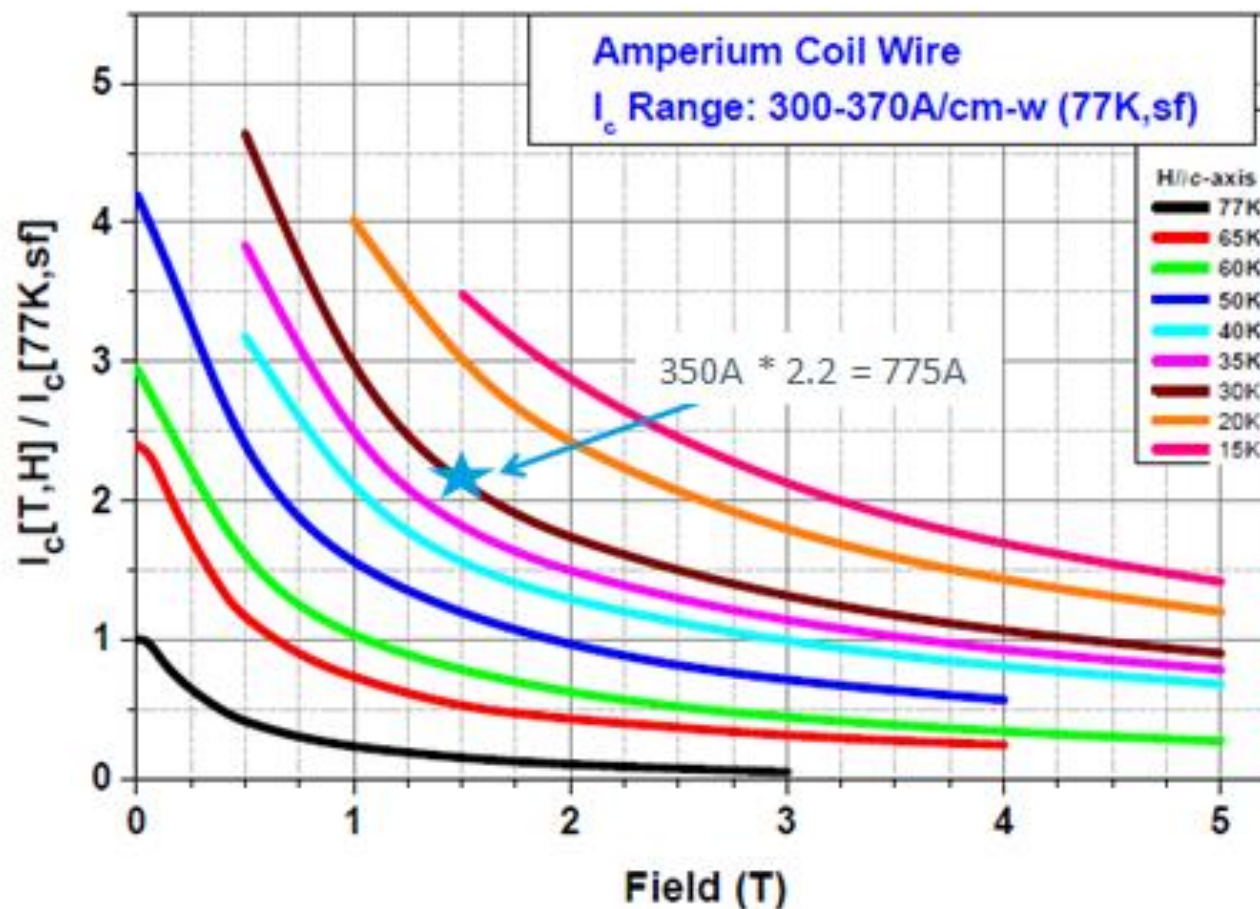
Wires addressing a wide range of power applications



Wire Type	Architecture	Minimum I_c 77 K, self-field, 1 μ V/cm	Wire Splicing	Applications	
<i>Standard Amperium Wires – See www.AMSC.com</i>					
Brass Laminated 4.4 8700		Single HTS, 3-layer, 4.4 mm wide, 150 μ m thick brass	80, 90, 100 A 140, 150, 160, 170, 180 A <i>Cable Formulation</i>	Factory spliced to ~1 km long	Resilient Electric Grid (REG), AC and DC Power Cables, Low Voltage DC Cables
Copper Laminated 4.8 8501		Single HTS, 3-layer, 4.8 mm wide, 50 μ m thick copper	80, 90, 100 A	Factory spliced to ~1 km long	Small Coils, Saturated Core FCLs, Magnets, SMES
Copper Laminated 12 8502		Single HTS, 3-layer, 12 mm wide, 50 μ m thick copper	200, 250 A, 350 A <i>Coil Formulation</i>	Factory Spliced to ~500m long	Large Coils, Generators, Motors, Large SMES
SS Laminated 12 8602		Single HTS, 3-layer, 12 mm wide, 75 μ m thick SS	200, 225, 250 A	Splice Free	Medium and High Voltage Resistive FCLs, Current Leads
SS Laminated 12 Double Insert 8612		Double HTS, 4-layer, 12 mm wide, 75 μ m thick SS	400, 450, 500 A	Splice Free	Medium and High Voltage Resistive FCLs

Amperium Coil Wire: I_c B T, //C

Production Wire, 8502-350, 12mm Copper Stabilized



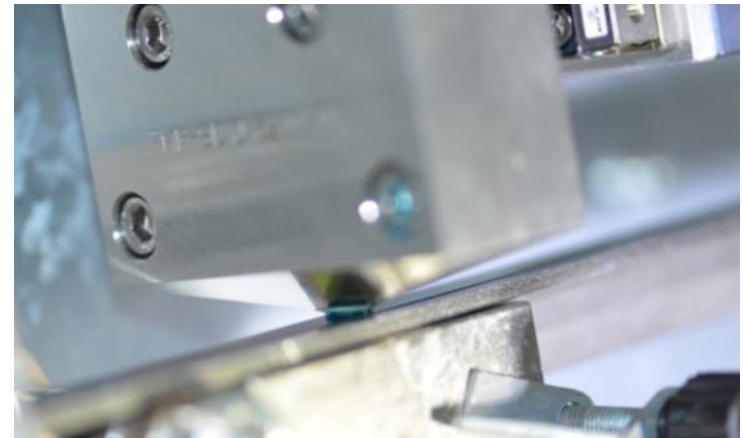
Process Technology

- Challenges for development and production
 - Best price performance ratio (€/kAm)
 - Scalable large volume production
 - Reliable and in-time supply
 - Flexible but mechanically and electrically stable



Process Technology

- Chemical solution deposition
 - Chemical solution deposition (CSD) for all layers is considered to be the „most promising and most challenging process“
 - Unique and protected CSD-multi-layer technology



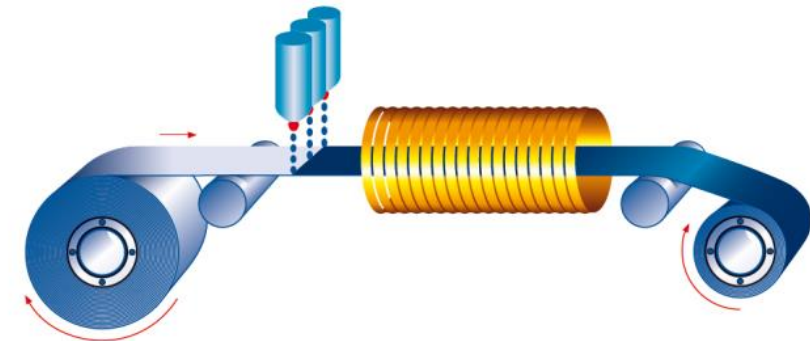
Process Technology

- Chemical solution deposition

Advantages:

- highest throughput (deposition rates)
- lowest investment
- lowest energy consumption
- low raw material costs

⇒ **favourable for energy applications**



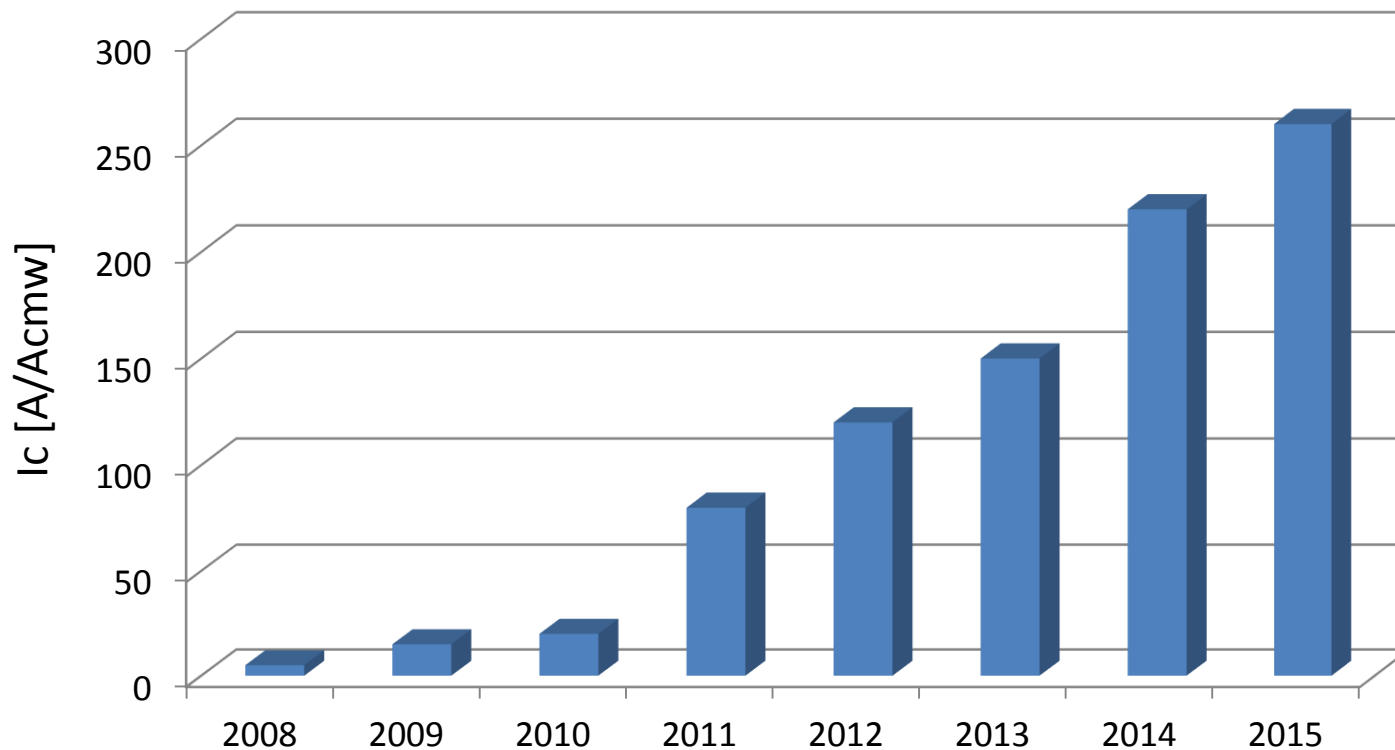
Continuous coating and annealing



Performance

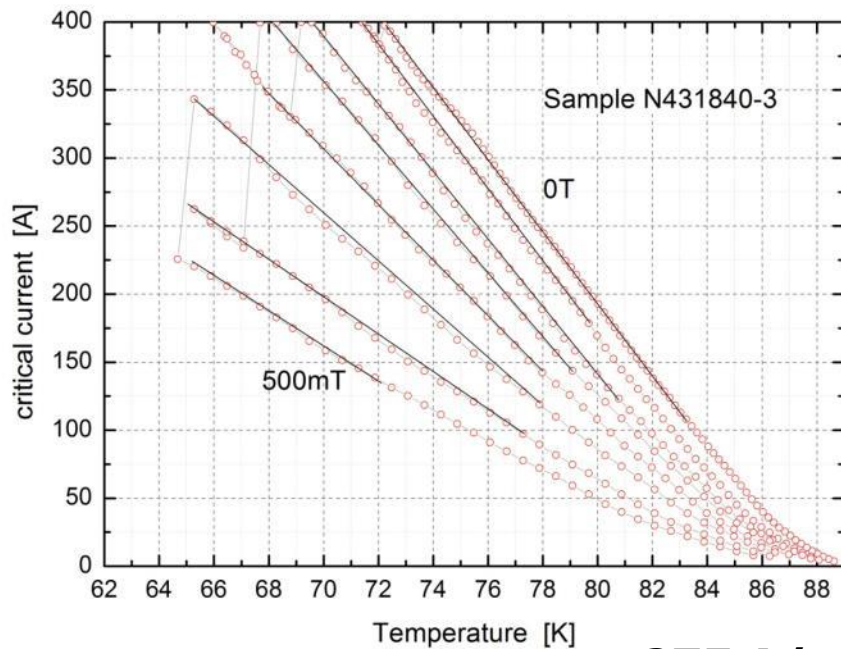
VDM Metals
Honeywell
Heraeus

- Development with industrial partners over nearly 10 years
 - Sample lengths increased from 5m (2018) towards >50m (2015)

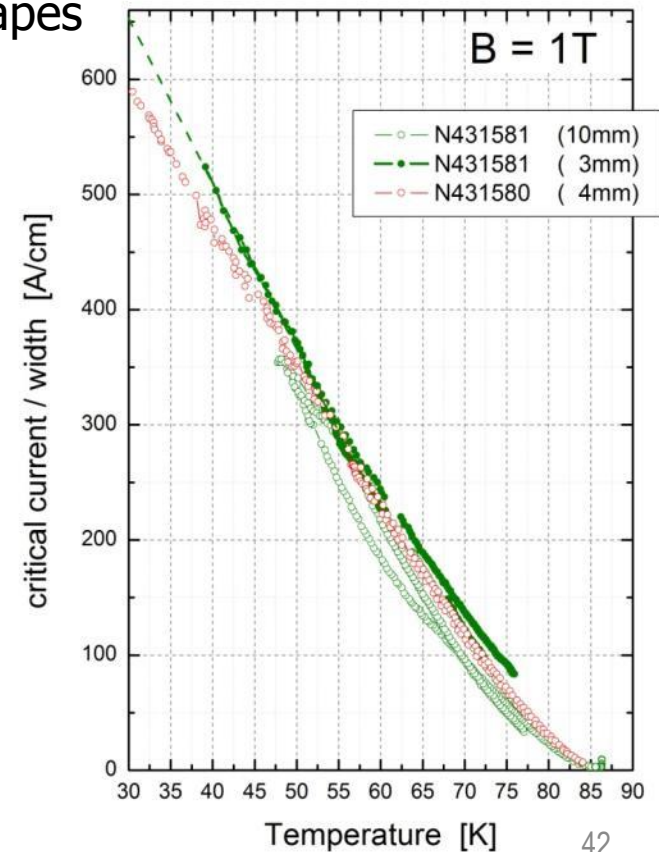


Performance

- Development with industrial partners over nearly 10 years
 - Short sample measurements of long length tapes



275 A/cmw @ 77K,sf
600 A/cmw @ 30K,1T
 (@1000nm HTS layer)



Expanded pilot line

- EPL construction until end 2015
- Planned capacity > 200km technical HTS wire
- Start sampling for projects mid 2016



Lab processing



Expanded Pilot Line

Kooperation BASF (Deutsche Nanoschicht) und AMSC



AMSC and BASF form strategic relationship to develop lower cost superconductor wire

- **BASF to license AMSC's second generation high temperature superconductor manufacturing technology**
- **Parties agree to develop advanced low cost manufacturing process for second generation high temperature superconductor**

DEVENS, MASSACHUSETTS, USA and LUDWIGSHAFEN, GERMANY – March 08, 2016 –

Zusammenfassung

„Flexible Supraleiterbänder mit hoher Stromtragfähigkeit für energietechnische und industrielle Anwendungen werden heute kommerziell hergestellt.“

www.ivsupra.de

- Ca. 10 Hersteller für HTS Bandleiter weltweit
- >5 Hersteller mit Pilotproduktionen zwischen 100 – 500km/a Kapazität
- Weltweite Kapazitäten ausreichend für Prototypen und Kleinserien
- Auslastung der Kapazitäten essentiell für weitere Aufskalierung und Kostenreduktion

chemistry meets energy

Vielen Dank für Ihre Aufmerksamkeit

Dr. Michael Bäcker

Deutsche Nanoschicht GmbH
Heisenbergstr. 16
53359 Rheinbach
www.d-nano.com



Federal Ministry
of Economics
and Technology

Die Landesregierung
Nordrhein-Westfalen



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Forschungszentrum Jülich